

## MOSFET – Power, N-Channel, SOT-23 200 mA, 50 V

## **BSS138L, BVSS138L**

Typical applications are DC-DC converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

#### **Features**

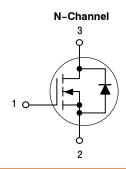
- Low Threshold Voltage (V<sub>GS(th)</sub>: 0.85 V-1.5 V) Makes it Ideal for Low Voltage Applications
- Miniature SOT-23 Surface Mount Package Saves Board Space
- HBM Class 0A, MM Class M1A, CDM Class IV (Note 3)
- BVSS Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Value	Unit
$V_{DSS}$	50	Vdc
$V_{GS}$	± 20	Vdc
I <sub>D</sub> I <sub>DM</sub>	200 800	mA
$P_{D}$	225	mW
T <sub>J</sub> , T <sub>stg</sub>	– 55 to 150	°C
$R_{\theta JA}$	556	°C/W
$T_L$	260	°C
	$\begin{array}{c} V_{DSS} \\ V_{GS} \\ \end{array}$ $\begin{array}{c} I_{D} \\ I_{DM} \\ \end{array}$ $\begin{array}{c} P_{D} \\ \end{array}$ $T_{J}, T_{stg} \\ \end{array}$ $R_{\theta JA}$	$\begin{array}{c cccc} V_{DSS} & 50 \\ \hline V_{GS} & \pm 20 \\ \hline & I_{D} & 200 \\ I_{DM} & 800 \\ \hline P_{D} & 225 \\ \hline T_{J}, T_{stg} & -55 \text{ to } 150 \\ \hline & R_{\theta JA} & 556 \\ \hline \end{array}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# 200 mA, 50 V $R_{DS(on)} = 3.5 Ω$





STYLE 21

# J1 M• •

MARKING

**DIAGRAM** 

J1 = Device Code

M = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BSS138LT1G, BVSS138LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel
BSS138LT7G	SOT-23 (Pb-Free)	3,500 / Tape & Reel
BSS138LT3G, BVSS138LT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

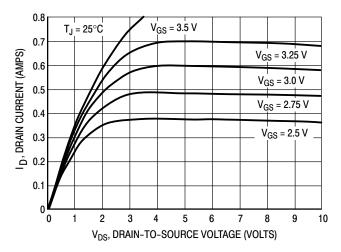
Characteristic			Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	
Drain-to-Source Breakdown Voltage (V <sub>GS</sub> = 0 Vdc, I <sub>D</sub> = 250 µAdc)			50	-	-	Vdc
Zero Gate Voltage Drain Current $ \begin{aligned} &(V_{DS}=25 \text{ Vdc}, V_{GS}=0 \text{ Vdc}, 25^{\circ}\text{C}) \\ &(V_{DS}=50 \text{ Vdc}, V_{GS}=0 \text{ Vdc}, 25^{\circ}\text{C}) \\ &(V_{DS}=50 \text{ Vdc}, V_{GS}=0 \text{ Vdc}, 150^{\circ}\text{C}) \end{aligned} $		I <sub>DSS</sub>	- - -	- - -	0.1 0.5 5.0	μAdc
Gate-Source Leakage Current (V <sub>GS</sub> = ± 20 Vdc, V <sub>DS</sub> = 0 Vdc)		I <sub>GSS</sub>	_	-	±0.1	μAdc
ON CHARACTERISTICS (Note 1						
Gate-Source Threshold Voltage $(V_{DS} = V_{GS}, I_D = 1.0 \text{ mAdc})$	V <sub>GS(th)</sub>	0.85	-	1.5	Vdc	
Static Drain-to-Source On-Resistance ( $V_{GS}$ = 2.75 Vdc, $I_D$ < 200 mAdc, $T_A$ = -40°C to +85°C) ( $V_{GS}$ = 5.0 Vdc, $I_D$ = 200 mAdc)		r <sub>DS(on)</sub>	_ _	5.6 -	10 3.5	Ω
Forward Transconductance (V <sub>DS</sub> = 25 Vdc, I <sub>D</sub> = 200 mAdc, f = 1.0 kHz)		9 <sub>fs</sub>	100	-	-	mmhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	(V <sub>DS</sub> = 25 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>iss</sub>	_	40	50	pF
Output Capacitance	(V <sub>DS</sub> = 25 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>oss</sub>	_	12	25	1
Transfer Capacitance	(V <sub>DG</sub> = 25 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>rss</sub>	_	3.5	5.0	1
SWITCHING CHARACTERISTIC	S (Note 2)	•	•	-	•	•
Turn-On Delay Time	() (0)/4-1 (0,0)4-)	t <sub>d(on)</sub>	_	-	20	ns
Turn-Off Delay Time	(V <sub>DD</sub> = 30 Vdc, I <sub>D</sub> = 0.2 Adc,)	t <sub>d(off)</sub>	_	_	20	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.

<sup>3.</sup> ESD between the gate and source serves only, no gate overvoltage rating is implied.

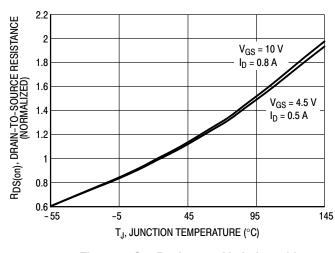
#### TYPICAL ELECTRICAL CHARACTERISTICS



0.9 25°C  $V_{DS} = 10 V$ 0.8 -55°C ID, DRAIN CURRENT (AMPS) 0.7 150°C 0.6 0.5 0.4 0.3 0.2 0.1 0.5 3 3.5 4.5 VGS, GATE-TO-SOURCE VOLTAGE (VOLTS)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



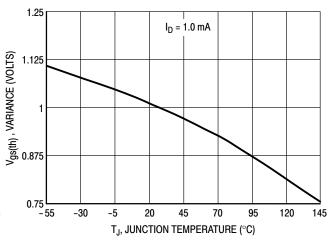
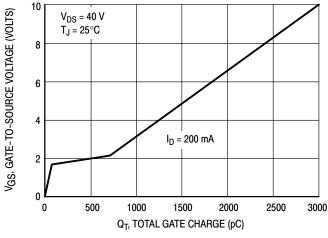


Figure 3. On–Resistance Variation with Temperature

Figure 4. Threshold Voltage Variation with Temperature



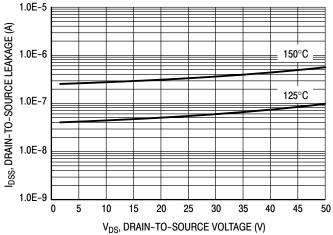
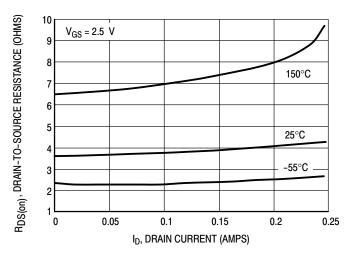


Figure 5. Gate Charge

Figure 6. IDSS

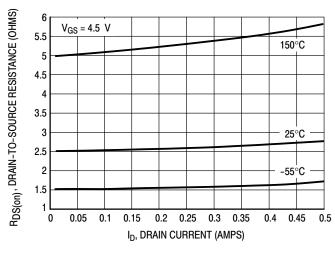
#### TYPICAL ELECTRICAL CHARACTERISTICS



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Figure 7. On-Resistance versus Drain Current

Figure 8. On-Resistance versus Drain Current



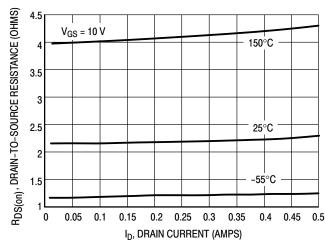
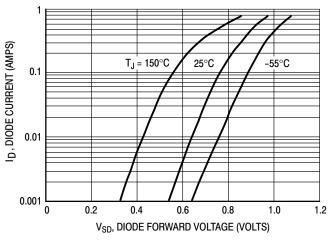


Figure 9. On-Resistance versus Drain Current

Figure 10. On-Resistance versus Drain Current



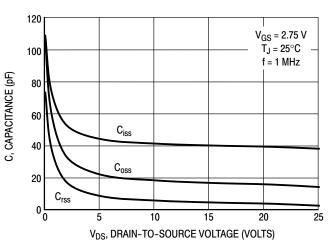


Figure 11. Body Diode Forward Voltage

Figure 12. Capacitance

#### TYPICAL ELECTRICAL CHARACTERISTICS

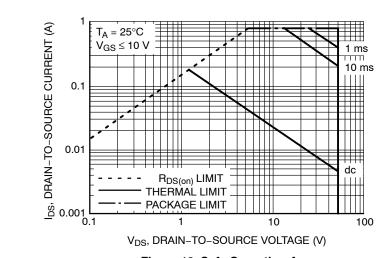


Figure 13. Safe Operating Area

**MILLIMETERS** 

MIN

0.89

0.01

0.37

0.08

2.80

1.20

1.78

0.30

0.35

2.10

O°

NOM

1.00

0.06

0.44

0.14

2.90

1.30

1.90

0.43

0.54

2.40

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#### SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**

**DATE 14 AUG 2024** 

MAX

1.11

0.10

0.50

0.20

3.04

1.40

2.04

0.55

0.69

2.64

10°

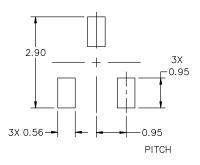




DETAIL "A" Scale 3:1







#### NOTES:

DIM

Α

Α1

b

С

D

Ε

е L

L1

HE

Τ

- DIMENSIONING AND TOLERANCING 1. PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- BASE MATERIAL.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

#### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

#### RECOMMENDED MOUNTING FOOTPRINT

\* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **STYLES ON PAGE 2**

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<sup>\*</sup>This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

#### SOT-23 (TO-236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR		NODE D CONNECTION ATHODE	
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	STYLE 11:         STYLE 12:           PIN 1. ANODE         PIN 1. CA           2. CATHODE         2. CA           3. CATHODE-ANODE         3. AN	ATHODE PIN 1. SOURCE ATHODE 2. DRAIN	STYLE 14: PIN 1. CATHODE 2. GATE 3. ANODE
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE			STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT	STYLE 23:         STYLE 24:           PIN 1. ANODE         PIN 1. GAT           2. ANODE         2. DR/           3. CATHODE         3. SOU	TE PIN 1. ANODE AIN 2. CATHODE	STYLE 26: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE			

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